

DATA SHEET

74ABT16825A

74ABTH16825A

18-bit buffer/line driver; non-inverting
(3-State)

Product specification
Supersedes data of 1995 Jul 14
IC23 Data Handbook

1998 Feb 25

18-bit buffer/line driver; non-inverting (3-State)

74ABT16825A
74ABTH16825A

FEATURES

- Multiple V_{CC} and GND pins minimize switching noise
- Live insertion/extraction permitted
- 3-State output buffers
- Power-up 3-State
- 74ABTH16825A incorporates bus-hold data inputs which eliminate the need for external pull-up resistors to hold unused inputs
- Output capability: +64mA/−32mA
- Latch-up protection exceeds 500mA per Jedec Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs

DESCRIPTION

The 74ABT16825A high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT16825A 18-bit buffers provide high performance bus interface buffering for wide data/address paths or buses carrying parity. They have NOR Output Enables ($n\overline{OE}1$, $n\overline{OE}2$) for maximum control flexibility.

Two options are available, 74ABT16825A which does not have the bus-hold feature and 74ABTH16825A which incorporates the bus-hold feature.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS $T_{amb} = 25^{\circ}\text{C}$; GND = 0V	TYPICAL	UNIT
t_{PLH} t_{PHL}	Propagation delay nA_x to nY_x	$C_L = 50\text{pF}$; $V_{CC} = 5\text{V}$	1.8 1.4	ns
C_{IN}	Input capacitance	$V_I = 0\text{V}$ or V_{CC}	4	pF
C_{OUT}	Output capacitance	$V_O = 0\text{V}$ or V_{CC} ; 3-State	6	pF
I_{CCZ}	Quiescent supply current	Outputs disabled; $V_{CC} = 5.5\text{V}$	500	μA
I_{CCL}		Outputs Low; $V_{CC} = 5.5\text{V}$	9	mA

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
56-pin SSOP Type III	−40°C to +85°C	74ABT16825A DL	BT16825A DL	SOT371-1
56-pin TSSOP Type II	−40°C to +85°C	74ABT16825A DGG	BT16825A DGG	SOT364-1
56-pin SSOP Type III	−40°C to +85°C	74ABTH16825A DL	BH16825A DL	SOT371-1
56-pin TSSOP Type II	−40°C to +85°C	74ABTH16825A DGG	BH16825A DGG	SOT364-1

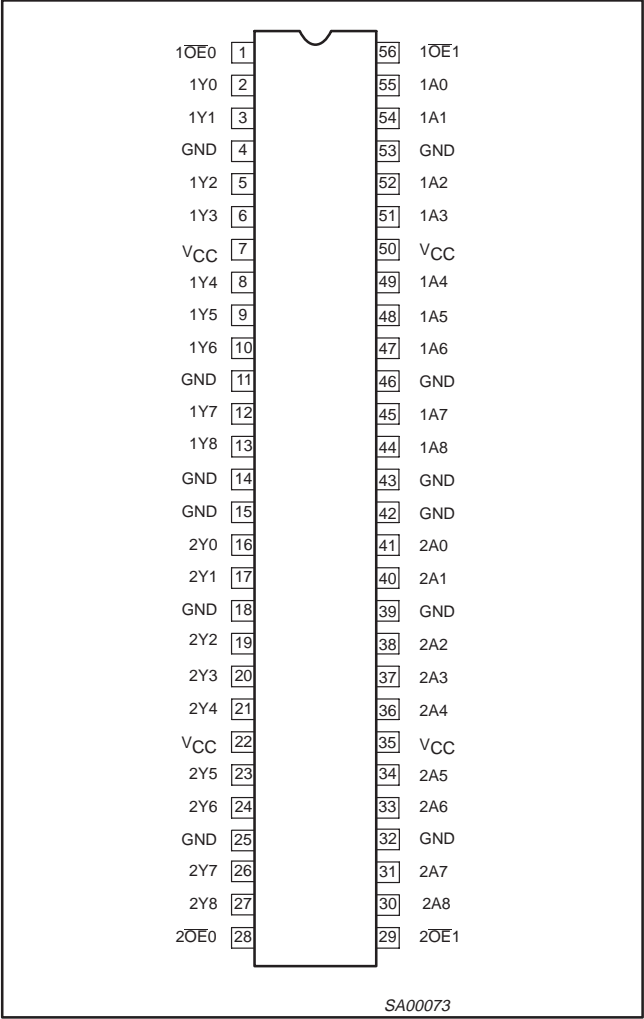
PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
55, 54, 52, 51, 49, 48, 47, 45, 44, 41, 40, 38, 37, 36, 34, 33, 31, 30	1A0 – 1A9 2A0 – 2A9	Data inputs
2, 3, 5, 6, 8, 9, 10, 12, 13 16, 17, 19, 20, 21, 23, 24, 26, 27	1Y0 – 1Y9 2Y0 – 2Y9	Data outputs
1, 56 28, 29	1OE0, 1OE1 2OE0, 2OE1	Output enable inputs (active-Low)
4, 11, 14, 15, 18, 25, 32, 39, 42, 43, 46, 53	GND	Ground (0V)
7, 22, 35, 50	V_{CC}	Positive supply voltage

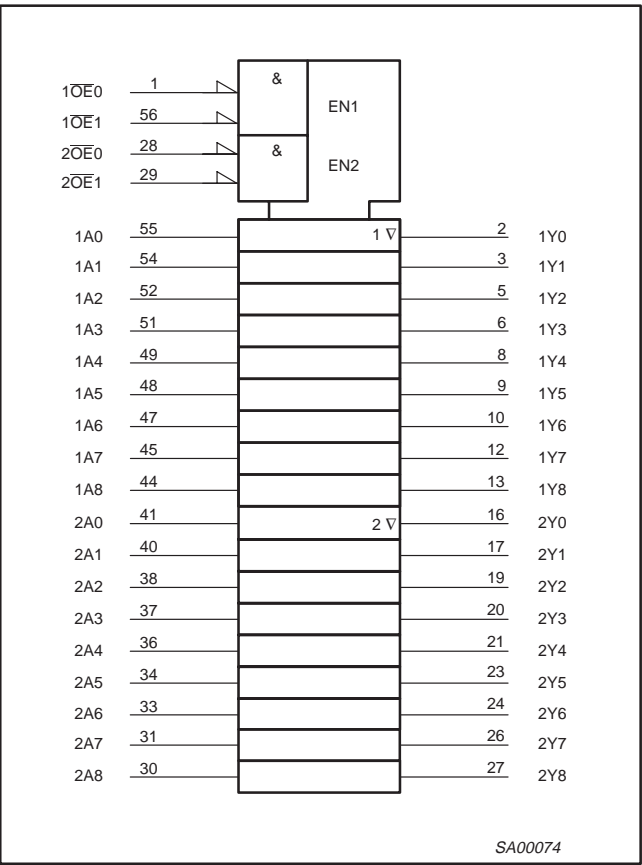
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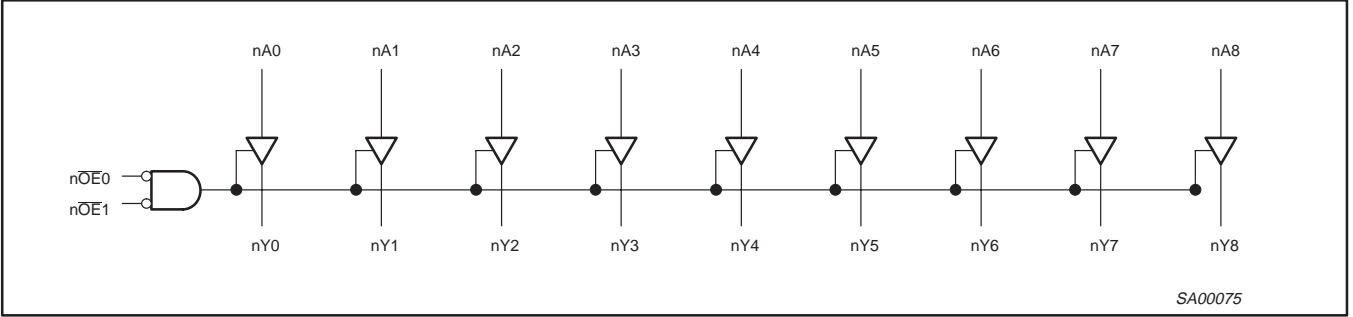
PIN CONFIGURATION



LOGIC SYMBOL (IEEE/IEC)



LOGIC DIAGRAM



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FUNCTION TABLE

INPUTS		OUTPUTS	OPERATING MODE
nOE _x	nA _x	nY _x	
L	L	L	Transparent
L	H	H	Transparent
H	X	Z	High impedance

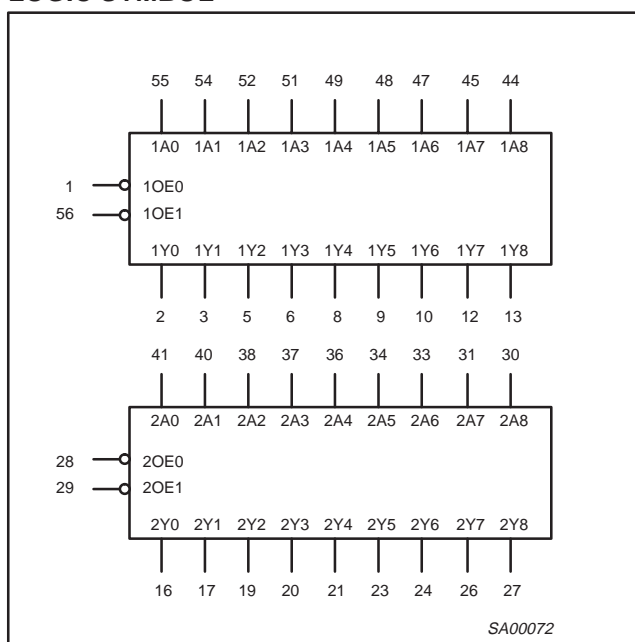
H = High voltage level

L = Low voltage level

X = Don't care

Z = High impedance "off" state

LOGIC SYMBOL

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
I _{IK}	DC input diode current	V _I < 0	-18	mA
V _I	DC input voltage ³		-1.2 to +7.0	V
I _{OK}	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	Output in Off or High state	-0.5 to +5.5	V
I _{OUT}	DC output current	Output in Low state	128	mA
		Output in High state	-64	
T _{stg}	Storage temperature range		-65 to 150	°C

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		MIN	MAX	
V _{CC}	DC supply voltage	4.5	5.5	V
V _I	Input voltage	0	V _{CC}	V
V _{IH}	High-level input voltage	2.0		V
V _{IL}	Low-level Input voltage		0.8	V
I _{OH}	High-level output current		-32	mA
I _{OL}	Low-level output current		64	mA
Δt/Δv	Input transition rise or fall rate	0	10	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C

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DC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITIONS		LIMITS					UNIT
				T _{amb} = +25°C			T _{amb} = −40°C to +85°C		
				MIN	TYP	MAX	MIN	MAX	
V _{IK}	Input clamp voltage	V _{CC} = 4.5V; I _{IK} = −18mA			−0.9	−1.2		−1.2	V
V _{OH}	High-level output voltage	V _{CC} = 4.5V; I _{OH} = −3mA; V _I = V _{IL} or V _{IH}		2.5	2.9		2.5		V
		V _{CC} = 5.0V; I _{OH} = −3mA; V _I = V _{IL} or V _{IH}		3.0	3.4		3.0		V
		V _{CC} = 4.5V; I _{OH} = −32mA; V _I = V _{IL} or V _{IH}		2.0	2.4		2.0		V
V _{OL}	Low-level output voltage	V _{CC} = 4.5V; I _{OL} = 64mA; V _I = V _{IL} or V _{IH}			0.42	0.55		0.55	V
I _I	Input leakage current ABT16825A	V _{CC} = 5.5V; V _I = GND or 5.5V			±0.01	±1.0		±1.0	μA
I _I	Input leakage current 74ABTH16825A	V _{CC} = 5.5V; V _I = V _{CC} or GND	Control pins		±0.01	±1		±1	μA
		V _{CC} = 5.5V; V _I = V _{CC}	Data pins ⁴		0.01	1		1	μA
		V _{CC} = 5.5V; V _I = 0			−1	−3		−5	μA
I _{HOLD}	Bus Hold current A inputs ⁵ 74ABTH16825A	V _{CC} = 4.5V; V _I = 0.8V		35			35		μA
		V _{CC} = 4.5V; V _I = 2.0V		−75			−75		
		V _{CC} = 5.5V; V _I = 0 to 5.5V		±500					
I _{OFF}	Power-off leakage current	V _{CC} = 0.0V; V _O = 4.5V; V _I = 0V or 5.5V			±5.0	±100		±100	μA
I _{PU} /I _{PD}	Power-up/down 3-State output current ³	V _{CC} = 2.1V; V _O = 0.5V; V _I = GND or V _{CC} ; V _{OE} = Don't care			±5.0	±50		±50	μA
I _{OZH}	3-State output High current	V _{CC} = 5.5V; V _O = 5.5V; V _I = V _{IL} or V _{IH}			1.0	10		10	μA
I _{OZL}	3-State output Low current	V _{CC} = 5.5V; V _O = 0.0V; V _I = V _{IL} or V _{IH}			−1.0	−10		−10	μA
I _{CEX}	Output High leakage current	V _{CC} = 5.5V; V _O = 5.5V; V _I = GND or V _{CC}			1.0	50		50	μA
I _O	Output current ¹	V _{CC} = 5.5V; V _O = 2.5V		−50	−70	−180	−50	−180	mA
I _{CCH}	Quiescent supply current	V _{CC} = 5.5V; Outputs High, V _I = GND or V _{CC}			0.5	1		1	mA
I _{CCL}		V _{CC} = 5.5V; Outputs Low, V _I = GND or V _{CC}			9	19		19	mA
I _{CCZ}		V _{CC} = 5.5V; Outputs 3-State; V _I = GND or V _{CC}			0.5	1		1	mA
ΔI _{CC}	Additional supply current per input pin ² 74ABT16825A	V _{CC} = 5.5V; one input at 3.4V, other inputs at V _{CC} or GND			10	500		500	μA
ΔI _{CC}	Additional supply current per input pin ² 74ABTH16825A	V _{CC} = 5.5V; one input at 3.4V, other inputs at V _{CC} or GND			0.2	1		1	mA

NOTES:

- Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
- This is the increase in supply current for each input at 3.4V.
- This parameter is valid for any V_{CC} between 0V and 2.1V with a transition time of up to 10msec. From V_{CC} = 2.1V to V_{CC} = 5V ± 10% a transition time of up to 100µsec is permitted.
- Unused pins at V_{CC} or GND.
- This is the bus hold overdrive current required to force the input to the opposite logic state.

AC CHARACTERISTICS

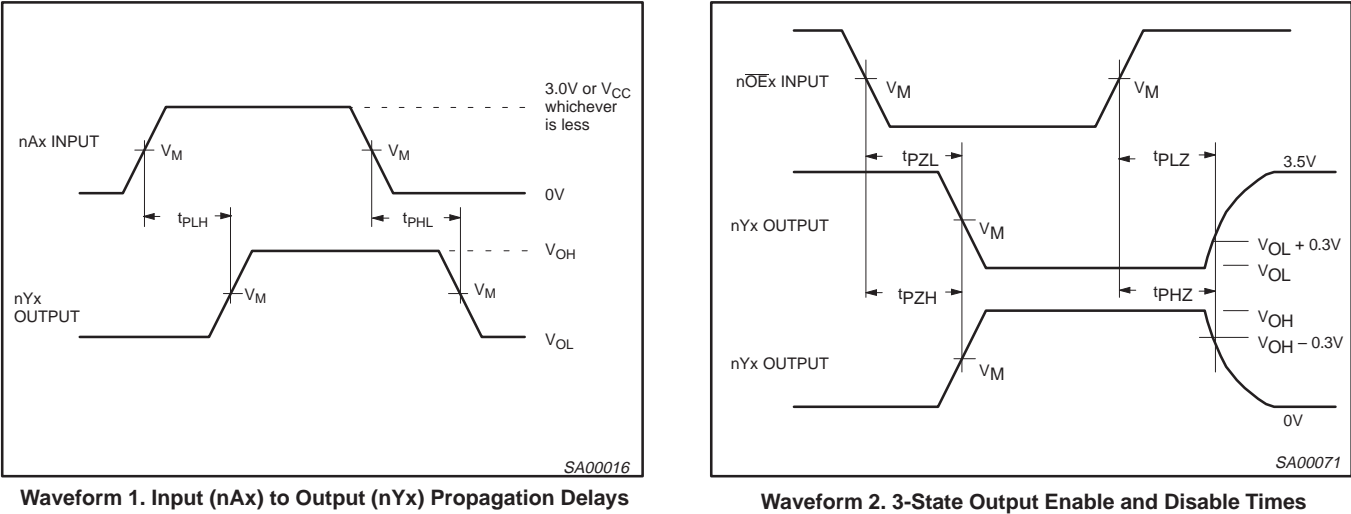
GND = 0V, t_R = t_F = 2.5ns, C_L = 50pF, R_L = 500Ω

SYMBOL	PARAMETER	WAVEFORM	LIMITS					UNIT
			T _{amb} = +25°C V _{CC} = +5.0V			T _{amb} = -40 to +85°C V _{CC} = +5.0V ±0.5V		
			MIN	TYP	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay nAx to nYx	1	1.0 0.6	1.8 1.4	2.5 2.0	1.0 0.6	2.8 2.3	ns
t _{PZH} t _{PZL}	Output enable time to High and Low level	2	1.0 1.0	2.9 2.9	3.8 3.8	1.0 1.0	4.8 5.0	ns
t _{PHZ} t _{PLZ}	Output disable time from High and Low level	2	2.0 1.6	3.3 2.5	4.5 3.4	2.0 1.6	5.2 3.7	ns

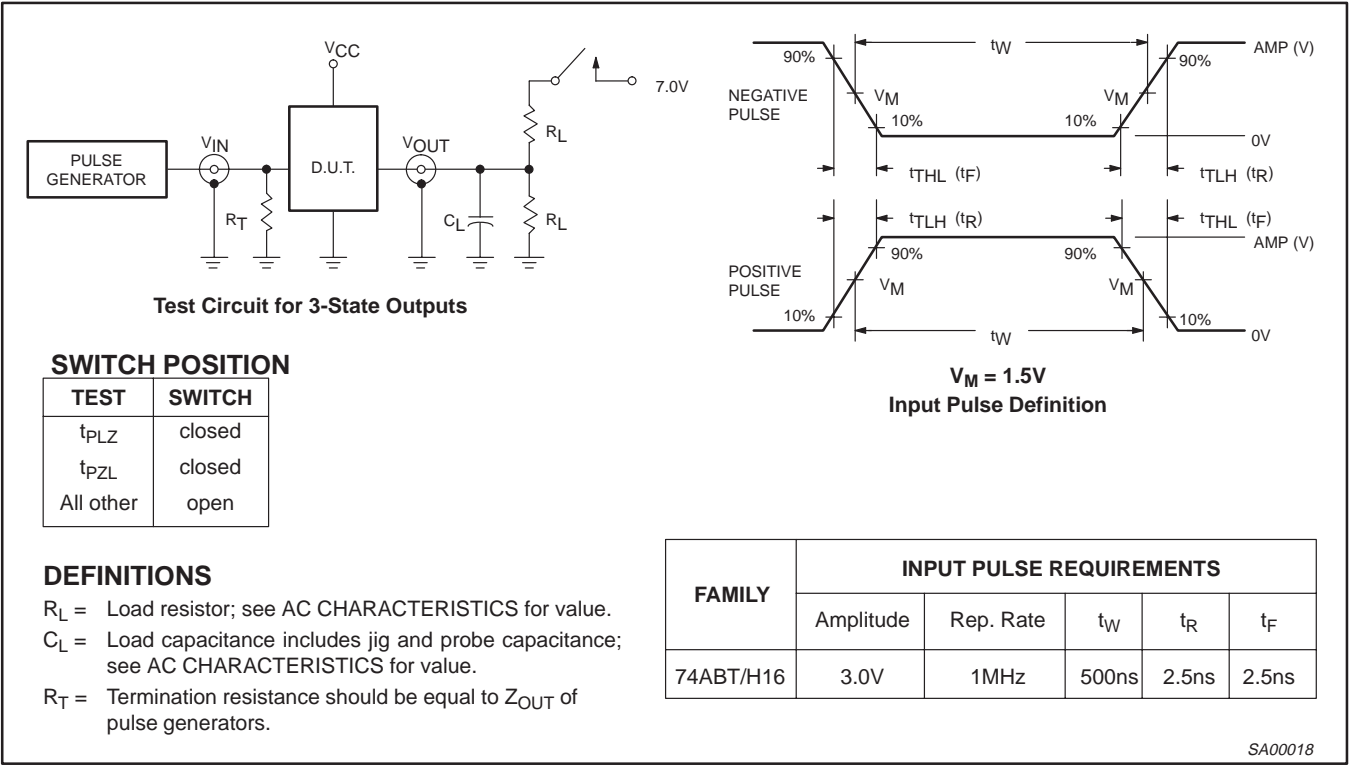
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AC WAVEFORMS



TEST CIRCUIT AND WAVEFORM

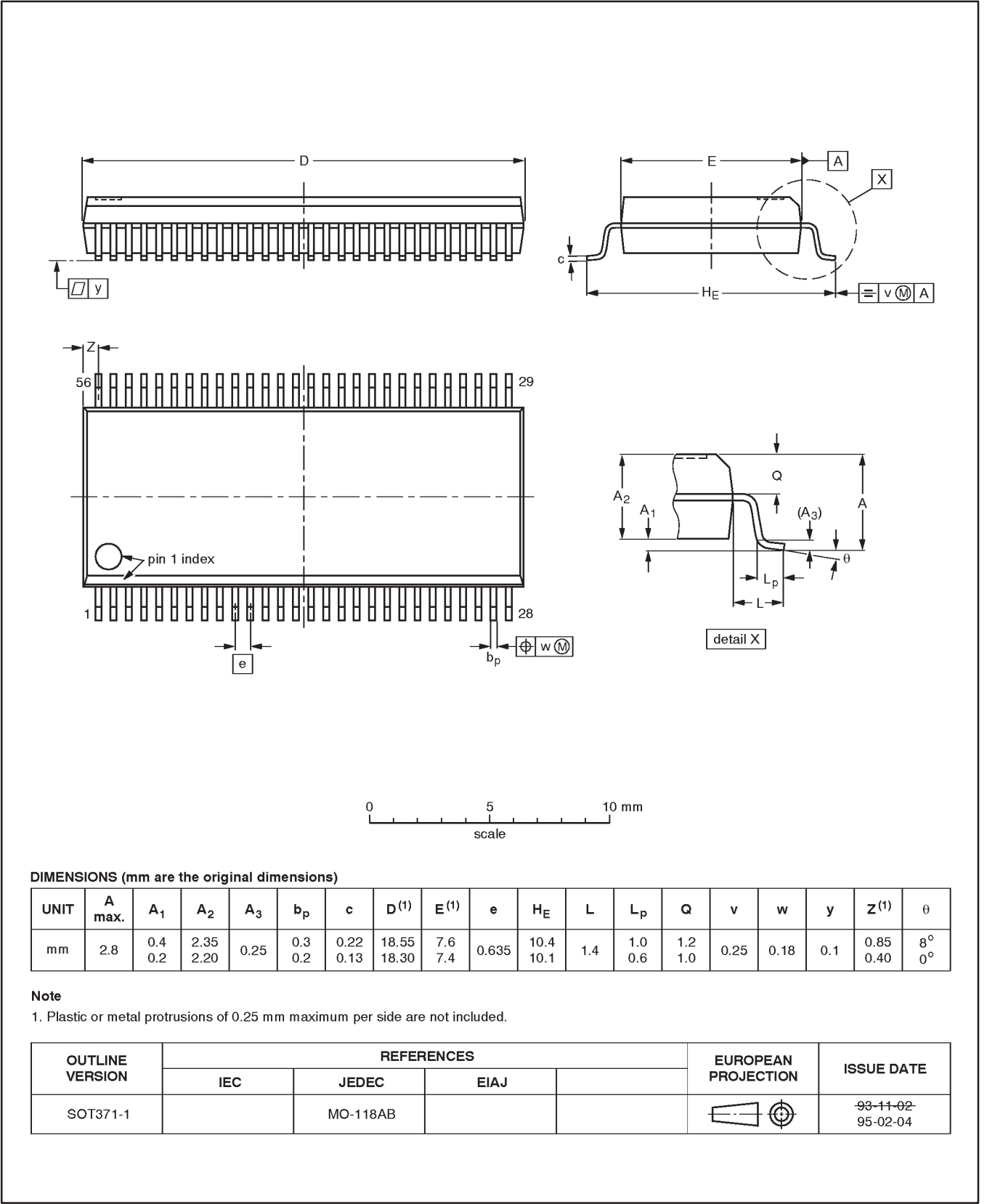


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SSOP56: plastic shrink small outline package; 56 leads; body width 7.5 mm

SOT371-1

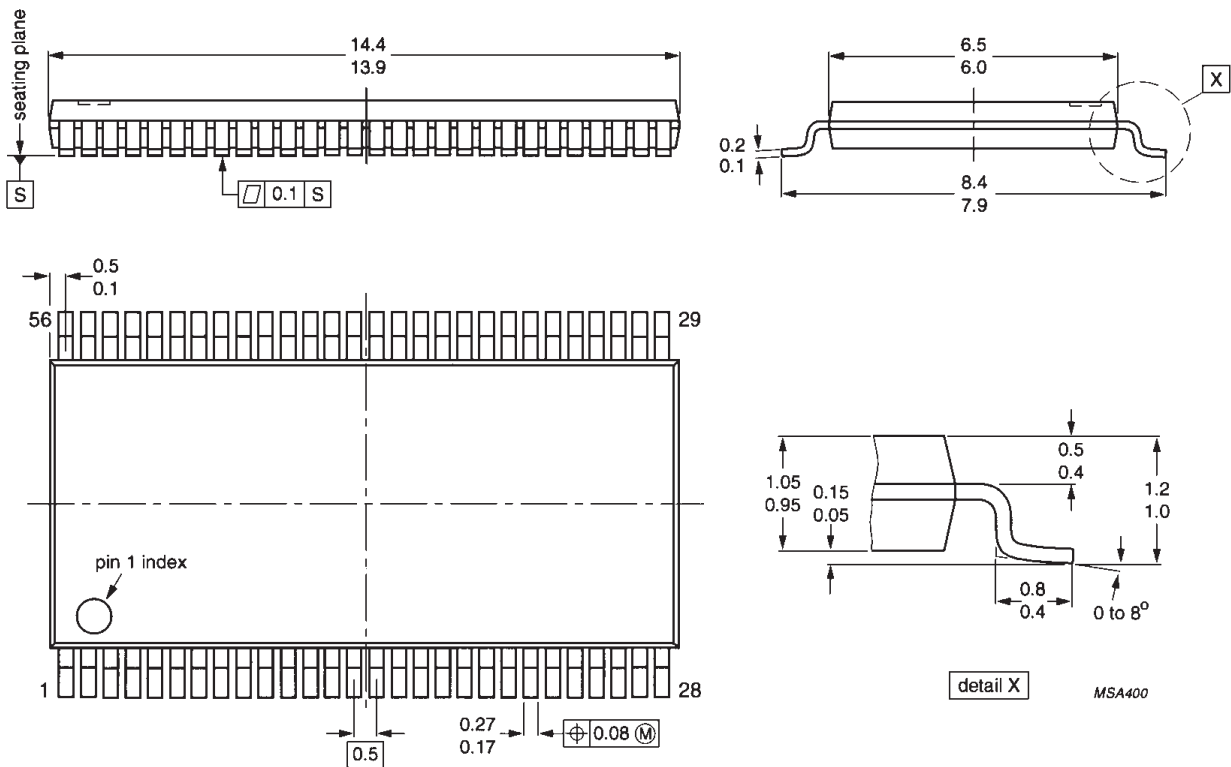


18-bit buffer/line driver; non-inverting (3-State)

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TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1mm

SOT364-1



Dimensions in mm.

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NOTES

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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